

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE3080K uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

V_{DS} =30V,I_D =80A

 $R_{DS(ON)}$ <6.5m Ω @ V_{GS} =10V

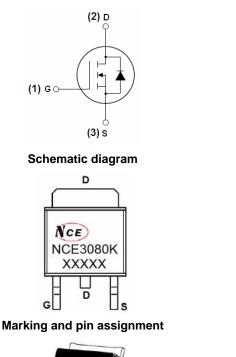
 $R_{DS(ON)}$ < 10m Ω @ V_{GS} =5V

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!





TO-252-2L top view

Package Marking and Ordering Information

	<u> </u>				
Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE3080K	NCE3080K	TO-252-2L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	80	Α
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	50	Α
Pulsed Drain Current	I _{DM}	170	Α
Maximum Power Dissipation	P _D	83	W
Derating factor		0.56	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	306	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 175	°C

NCE3080K

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	R _{eJC}	1.8	°C/W	
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Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics	<u>.</u>						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	30	-	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μΑ	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1	1.6	3	V	
Drain Course On State Besistense	R _{DS(ON)}	V _{GS} =10V, I _D =30A	-	5.5	6.5	- mΩ	
Drain-Source On-State Resistance		V _{GS} =5V, I _D =24A	-	7.5	10		
Forward Transconductance	g FS	V _{DS} =5V,I _D =24A	20	-	-	S	
Dynamic Characteristics (Note4)	<u> </u>		•				
Input Capacitance	C _{lss}	\/ -45\/\/ -0\/	-	2016	-	PF	
Output Capacitance	C _{oss}	V_{DS} =15V, V_{GS} =0V, F=1.0MHz	-	251	-	PF	
Reverse Transfer Capacitance	C _{rss}	F=1.UIVIDZ	-	230	-	PF	
Switching Characteristics (Note 4)							
Turn-on Delay Time	t _{d(on)}		-	20	-	nS	
Turn-on Rise Time	t _r	V _{DD} =10V,I _D =30A	-	15	-	nS	
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{GEN} =2.7 Ω	-	60	-	nS	
Turn-Off Fall Time	t _f		-	10	-	nS	
Total Gate Charge	Qg	V _{DS} =10V,I _D =30A,	-	60.5	-	nC	
Gate-Source Charge	Q_{gs}	$V_{DS}=10V,I_{D}=30A,$ $V_{GS}=10V$	-	8.1	-	nC	
Gate-Drain Charge	Q_{gd}	VGS-10V	-	7.8	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =24A	-	-	1.2	V	
Diode Forward Current (Note 2)	Is		-	-	80	Α	
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 80A	-	32	50	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	12	20	nC	
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+				y LS+LD)	

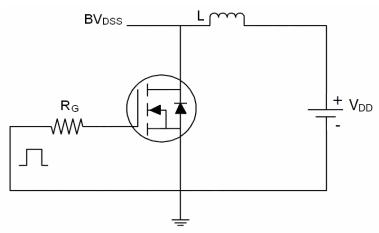
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25 $^{\circ}$ C,V_{DD}=15V,V_G=10V,L=0.5mH,Rg=25 Ω , I_{AS}=35A

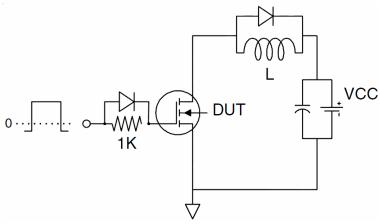


Test Circuit

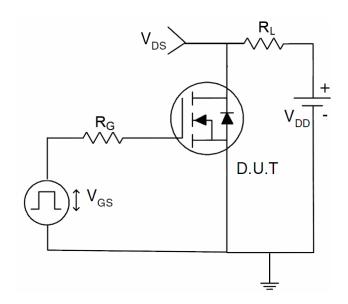
1) E_{AS} Test Circuits



2) Gate Charge Test Circuit:



3) Switch Time Test Circuit:





Typical Electrical and Thermal Characteristics (Curves)

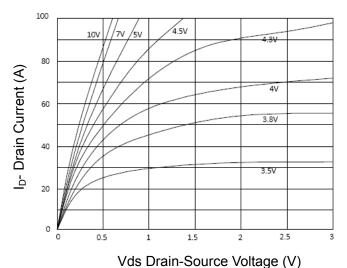


Figure 1 Output Characteristics

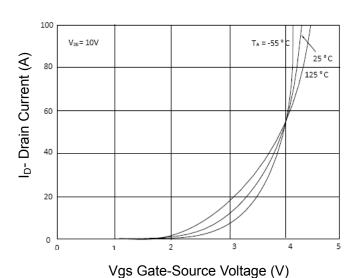


Figure 2 Transfer Characteristics

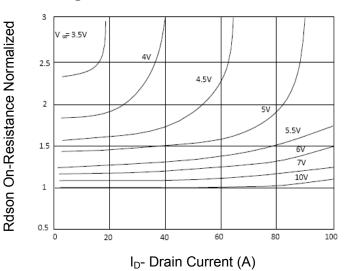


Figure 3 Rdson- Drain Current

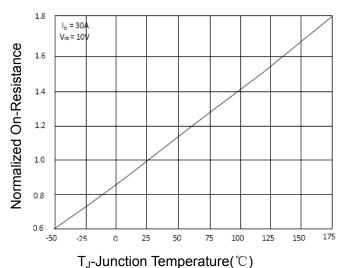


Figure 4 Rdson-JunctionTemperature

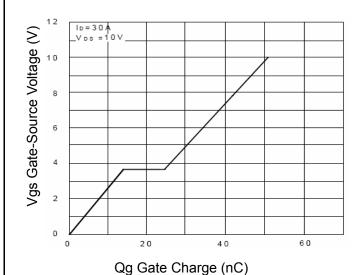


Figure 5 Gate Charge

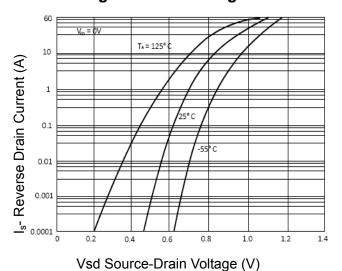
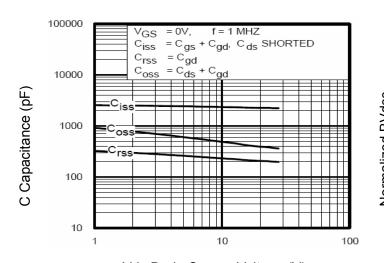


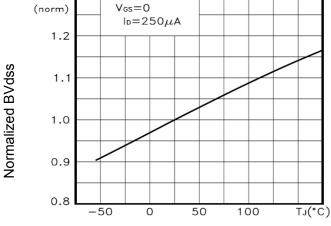
Figure 6 Source- Drain Diode Forward





Vds Drain-Source Voltage (V)

Figure 7 Capacitance vs Vds



BVDSS

 T_J -Junction Temperature (°C) Figure 9 BV_{DSS} vs Junction Temperature

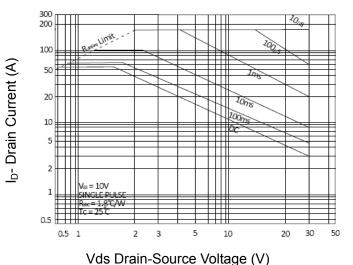
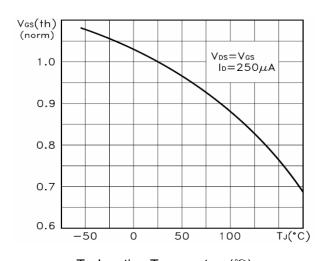
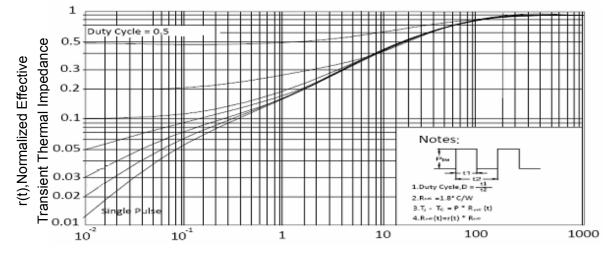


Figure 8 Safe Operation Area



 $\mathsf{T}_{\mathsf{J}} ext{-Junction Temperature}(^{\circ}\!\mathbb{C})$

Figure 10 V_{GS(th)} vs Junction Temperature

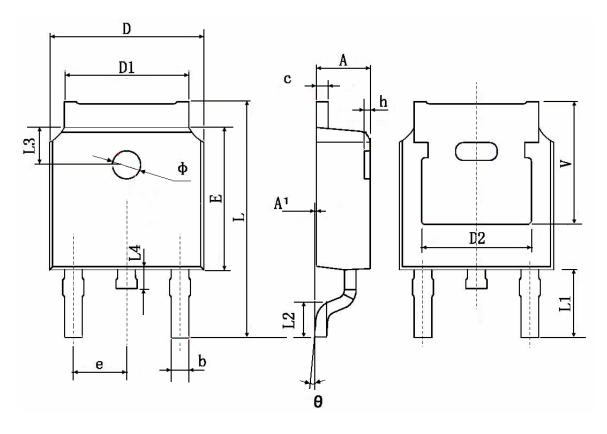


Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



TO-252 Package Information



Comple of	Dimensions	In Millimeters	Dimensions In Inches			
Symbol	Min.	Max.	Min.	Max.		
A	2.200	2.400	0.087	0.094		
A1	0.000	0.127	0.000	0.005		
b	0.660	0.860	0.026	0.034		
С	0.460	0.580	0.018	0.023		
D	6.500	6.700	0.256	0.264		
D1	5.100	5.460	0.201	0.215		
D2	4.8	30 TYP.	0.190 TYP.			
E	6.000	6.200	0.236	0.244		
е	2.186	2.386	0.086	0.094		
L	9.800	10.400	0.386	0.409		
L1	2.900	TYP.				
L2	1.400	1.700	0.055	0.067		
L3	1.600	0.063 TYP.		1.600 TYP.		TYP.
L4	0.600	1.000	0.024	0.039		
Ф	1.100	1.300	0.043	0.051		
θ	0°	8°	0°	8°		
h	0.000	0.300	0.000	0.012		
V	5.350 TYP.		0.211 TYP.			



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